

# CISPR 25, Class 5, 400-kHz-Rated, 60-W Automotive, Single USB Type-C PD Charger Reference Design



## Description

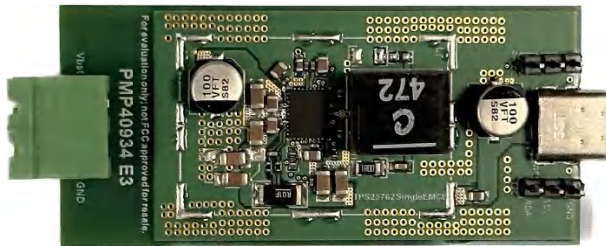
This reference design is an EMI-optimized design for an automotive USB Type-C® power delivery (PD) charger with a single output. The TPS25762-Q1 is used as DC-DC regulator and port controller. The PCB layout is optimized to pass stringent CISPR 25 Class 5 Conducted Electromagnetic Interference (EMI) standards. This reference design has already been tested to CISPR 25 Class 5 conducted EMI standards, which accelerates customer design time.

## Features

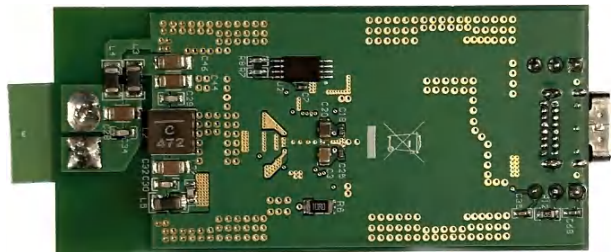
- Compliant to CISPR 25 Class 5 EMI standard
- High efficiency with 95.78% peak efficiency
- Cost-efficient without common-mode inductor

## Applications

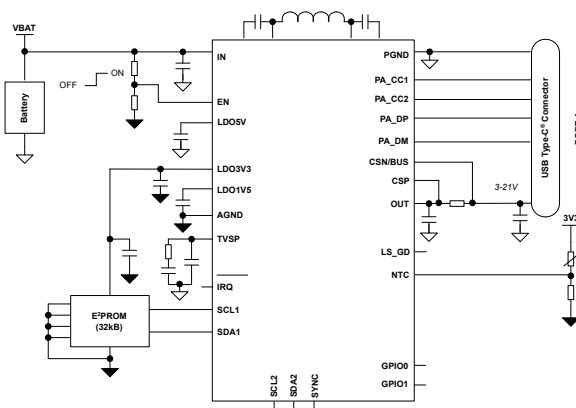
- [Automotive USB charge](#)



Board Photo (Top)



Board Photo (Bottom)



Block Diagram

## 1 Test Prerequisites

### 1.1 Voltage and Current Requirements

**Table 1-1. Voltage and Current Requirements**

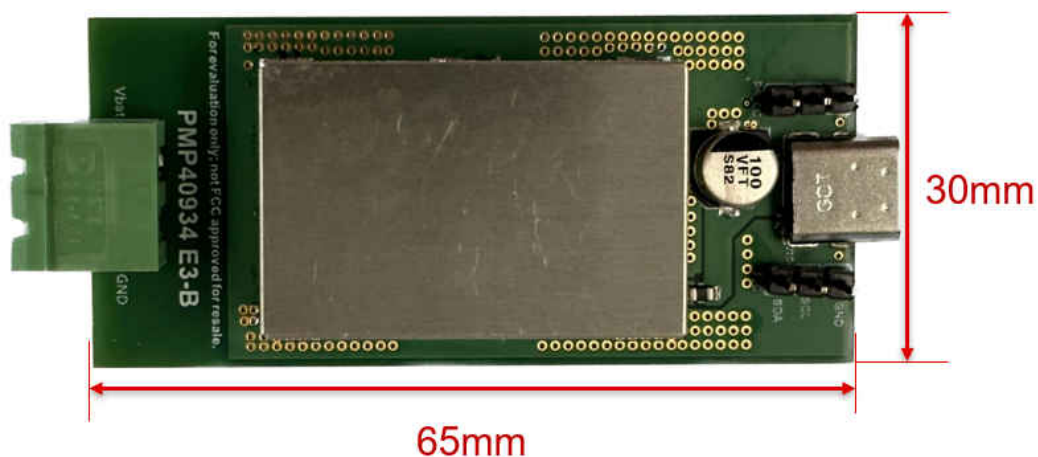
Parameter	Specifications
Input Voltage	13.5 Vdc
PA_BUS Output Voltage	5 VDC, 9 VDC, 15 VDC, 20 VDC
PA_BUS Maximum Output Current	3 A
Switching Frequency	400 kHz

### 1.2 Required Equipment

- Multimeter (current): Fluke 287C
- Multimeter (voltage): Fluke 287C
- DC Source: Chroma 62006P-100-25
- E-Load: Chroma 63103A module
- Oscilloscope: Tektronix DPO4104B
- Electrical Thermography: Fluke TiS55
- Thermal Data Acquisition: Agilent 34970A

### 1.3 Dimensions

The board dimensions are 65 mm (length) × 30 mm (width) × 10 mm (height, ignore J1).



The board image as represented here is not actual size.

**Figure 1-1. Board Dimensions**

## 2 Testing and Results

### 2.1 Efficiency Graphs

The following image shows the efficiency graph.

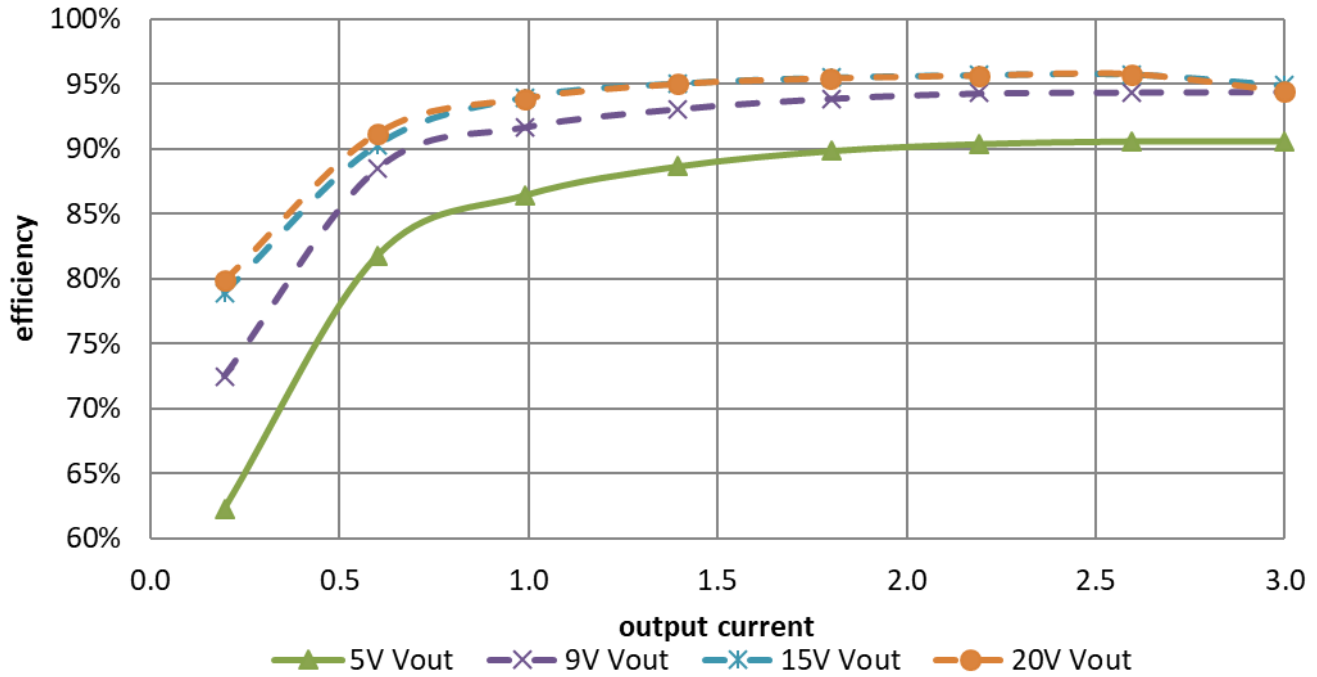


Figure 2-1. Efficiency Graph

### 2.2 Efficiency Data

V <sub>IN</sub> (V)	I <sub>IN</sub> (A)	P <sub>IN</sub> (W)	V <sub>OUT</sub> (V)	I <sub>OUT</sub> (A)	P <sub>OUT</sub> (W)	Efficiency
13.503	0.117	1.580	4.9967	0.1969	0.984	62.28%
13.496	0.272	3.671	4.9967	0.6009	3.003	81.80%
13.488	0.425	5.733	4.9964	0.9919	4.956	86.45%
13.481	0.583	7.859	4.9956	1.395	6.969	88.67%
13.474	0.743	10.011	4.9951	1.8009	8.996	89.86%
13.466	0.899	12.106	4.9946	2.1909	10.943	90.39%
13.459	1.063	14.307	4.9939	2.5959	12.964	90.61%
13.451	1.229	16.531	4.9933	3.0000	14.980	90.61%
13.516	0.181	2.446	9.0019	0.1969	1.772	72.45%
13.507	0.453	6.119	8.9987	0.6019	5.416	88.52%
13.497	0.721	9.731	8.9957	0.9919	8.923	91.69%
13.487	0.999	13.474	8.9913	1.3950	12.543	93.09%
13.477	1.279	17.237	8.9875	1.8009	16.186	93.90%
13.467	1.549	20.860	8.9830	2.1900	19.673	94.31%
13.457	1.835	24.694	8.9788	2.5959	23.308	94.39%
13.447	2.121	28.521	8.9746	3.0009	26.932	94.43%
13.512	0.277	3.743	14.9967	0.1969	2.953	78.89%
13.496	0.739	9.974	14.9920	0.6009	9.009	90.33%

<b>V<sub>IN</sub> (V)</b>	<b>I<sub>IN</sub> (A)</b>	<b>P<sub>IN</sub>(W)</b>	<b>V<sub>OUT</sub> (V)</b>	<b>I<sub>OUT</sub> (A)</b>	<b>P<sub>OUT</sub>(W)</b>	<b>Efficiency</b>
13.481	1.172	15.800	14.9880	0.9909	14.852	94.00%
13.464	1.633	21.987	14.9837	1.3950	20.902	95.07%
13.447	2.099	28.225	14.9790	1.8000	26.962	95.53%
13.431	2.551	34.262	14.9750	2.1900	32.795	95.72%
13.413	3.024	40.561	14.9703	2.5950	38.848	95.78%
13.515	3.500	47.303	14.9648	3.0000	44.894	94.91%
13.508	0.363	4.903	19.9907	0.1959	3.916	79.87%
13.486	0.975	13.149	19.9867	0.6000	11.992	91.20%
13.465	1.565	21.073	19.9827	0.9900	19.783	93.88%
13.443	2.181	29.319	19.9784	1.3941	27.852	95.00%
13.420	2.806	37.657	19.9736	1.7991	35.935	95.43%
13.398	3.413	45.727	19.9700	2.1900	43.734	95.64%
13.373	4.048	54.134	19.9662	2.5960	51.832	95.75%
13.514	4.693	63.421	19.9614	3.0000	59.884	94.42%

### 2.3 Thermal Images

The following figures show the thermal images. The ambient temperature is 25°C, and the thermal images were taken with 13.5-V input and the output at a full load of 3 A. The controller was operated for approximately 30 minutes before thermal images were taken to make sure the thermal steady state was reached. The board uses 4-layer PCB, the top and bottom layers of copper are 2 oz, and the middle layers of copper are 1 oz.

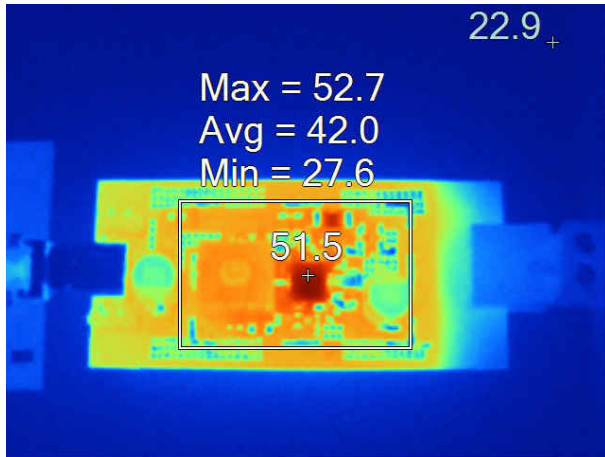


Figure 2-2. Top Side Thermal Image, 5-V, 3-A Load

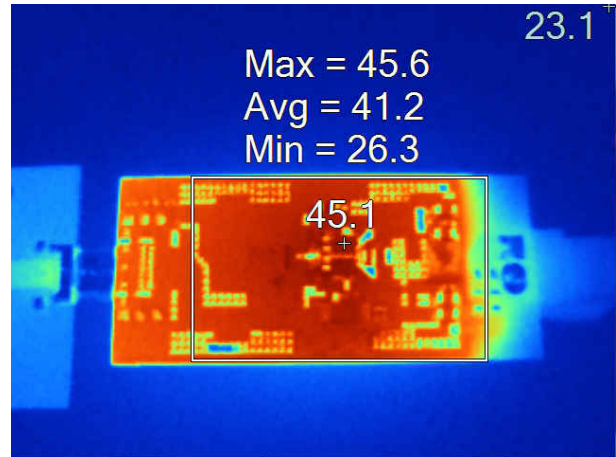


Figure 2-3. Bottom Side Thermal Image, 5-V, 3-A Load

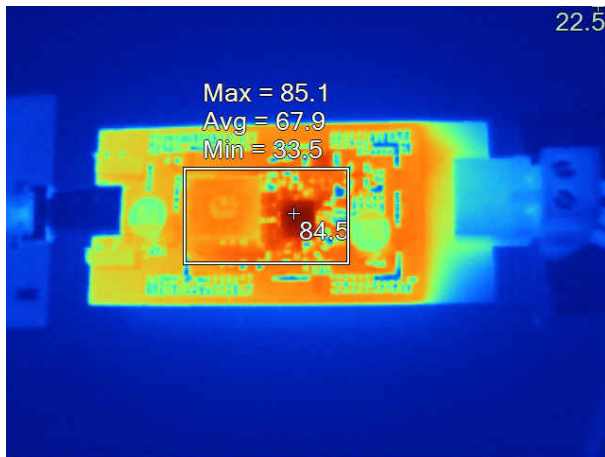


Figure 2-4. Top Side Thermal Image, 20-V, 3-A Load

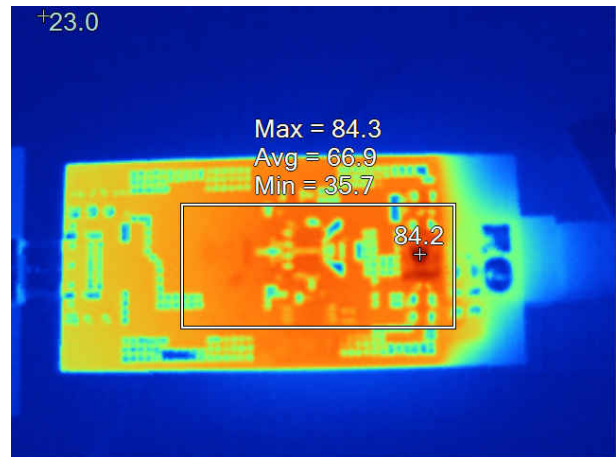


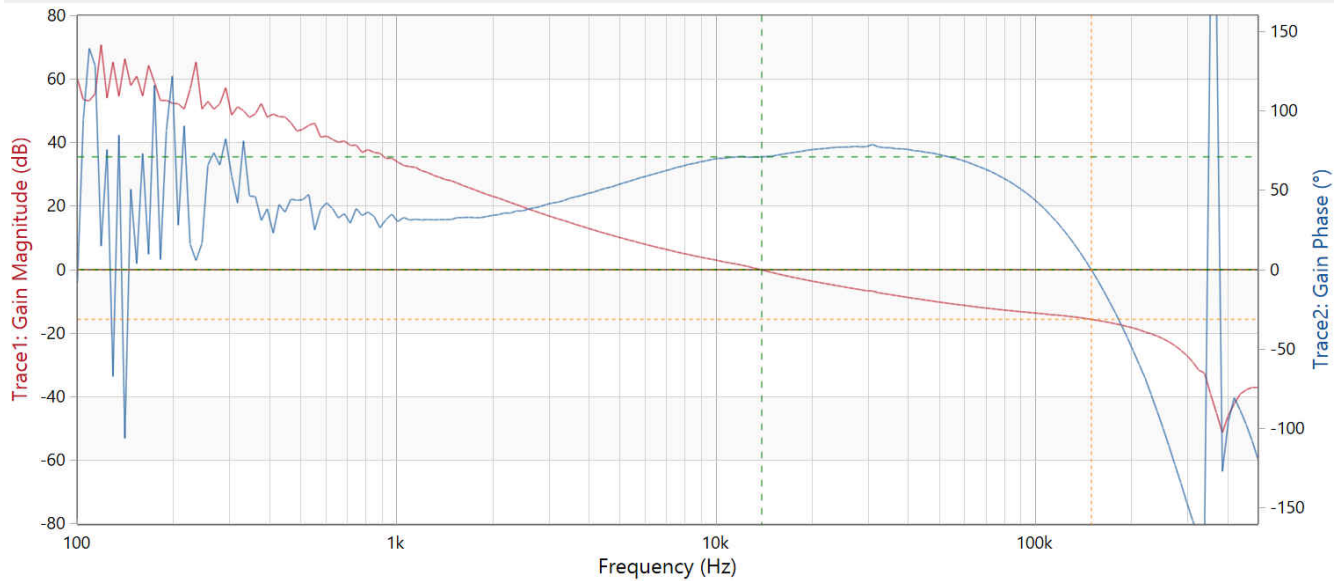
Figure 2-5. Bottom Side Thermal Image, 20-V, 3-A Load

## 2.4 Bode Plots

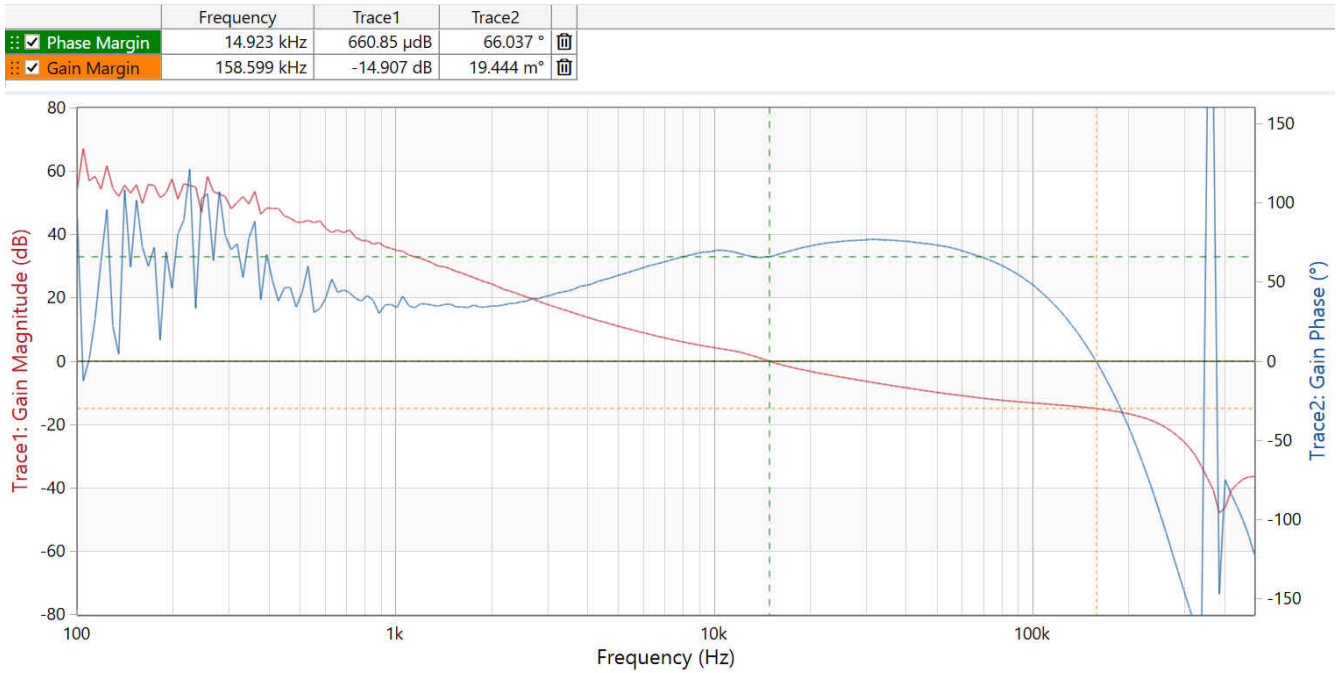
**Table 2-1. Phase Margin and Gain Margin**

V <sub>IN</sub>	V <sub>OUT</sub>	Phase Margin (°)	Gain Margin (dB)
9 V	5 V	68.989	14.606
9 V	9 V	57.768	10.269
9 V	15 V	52.433	11.264
13.5 V	5 V	71.098	15.637
13.5 V	9 V	66.037	14.908
13.5 V	15 V	61.061	8.555
13.5 V	20 V	58.445	10.692
16 V	5 V	71.659	15.843
16 V	9 V	68.851	14.14
16 V	15 V	64.409	11.835
16 V	20 V	59.821	8.923

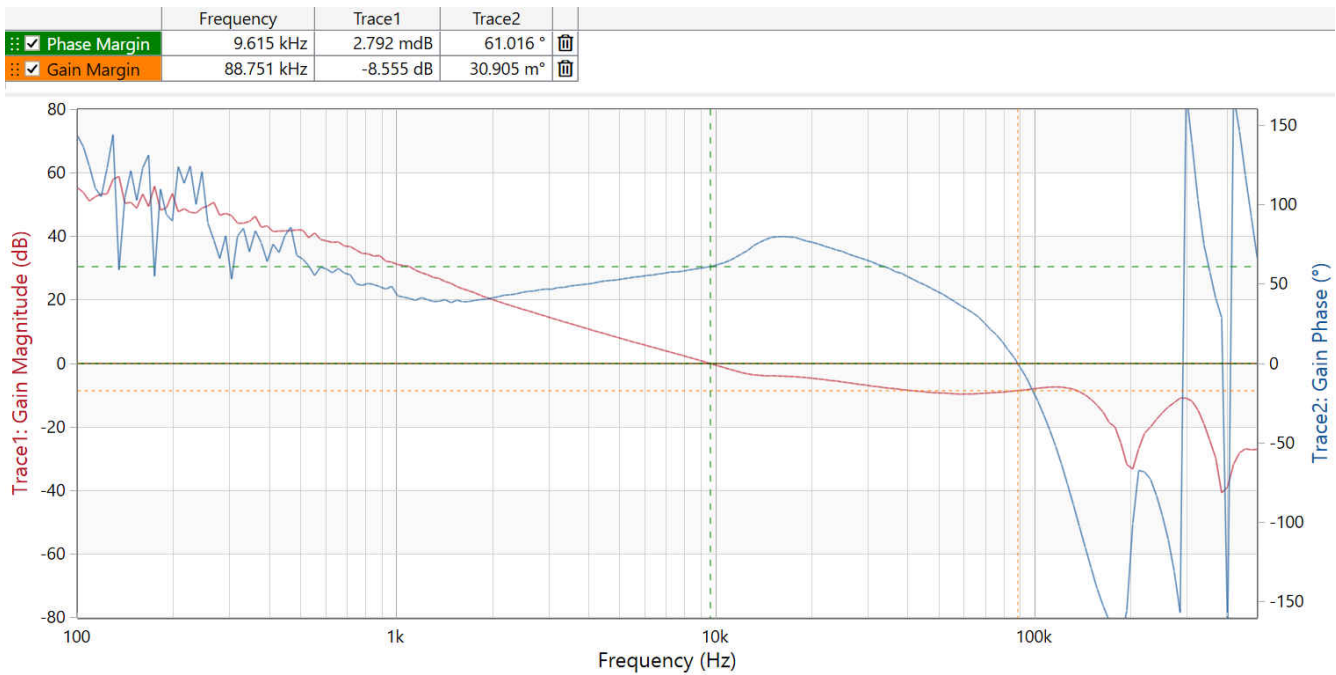
	Frequency	Trace1	Trace2
Phase Margin	13.862 kHz	1.886 mdB	71.097 °
Gain Margin	150.24 kHz	-15.636 dB	10.74 m°



**Figure 2-6. Bode Plot, 13.5-V Input, 5-V, 3-A Load**

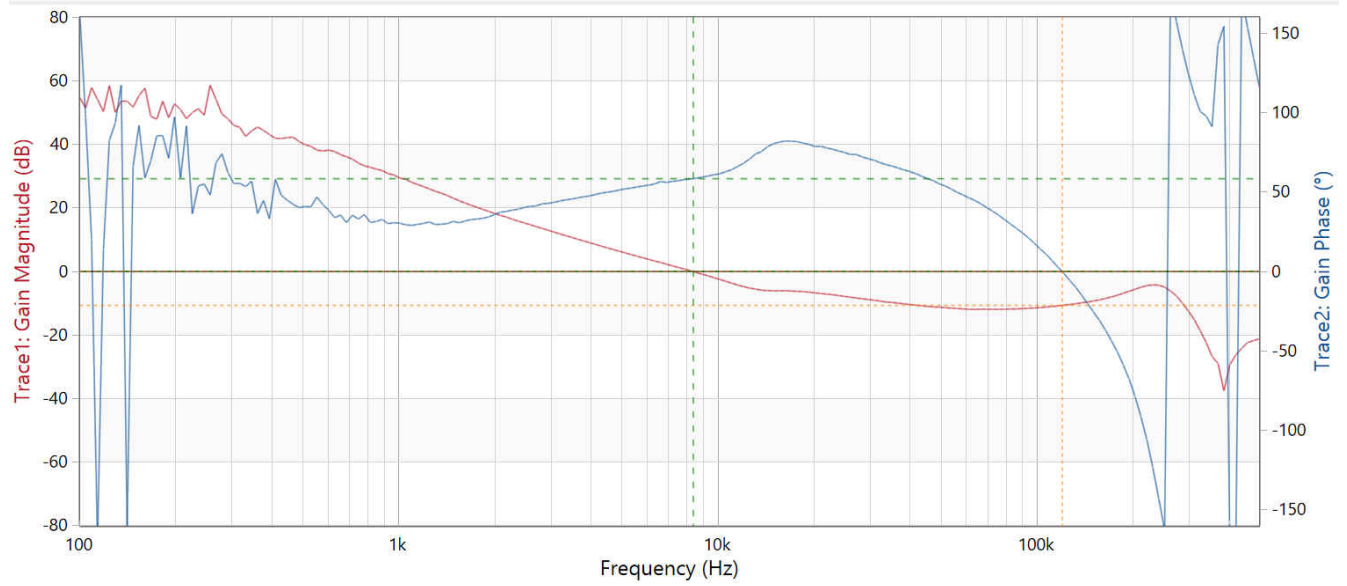


**Figure 2-7. Bode Plot, 13.5-V Input, 9-V, 3-A Load**



**Figure 2-8. Bode Plot, 13.5-V Input, 15-V, 3-A Load**

	Frequency	Trace1	Trace2	
Phase Margin	8.346 kHz	2.794 mdB	58.443 °	🗑️
Gain Margin	120.171 kHz	-10.693 dB	18.081 m°	🗑️



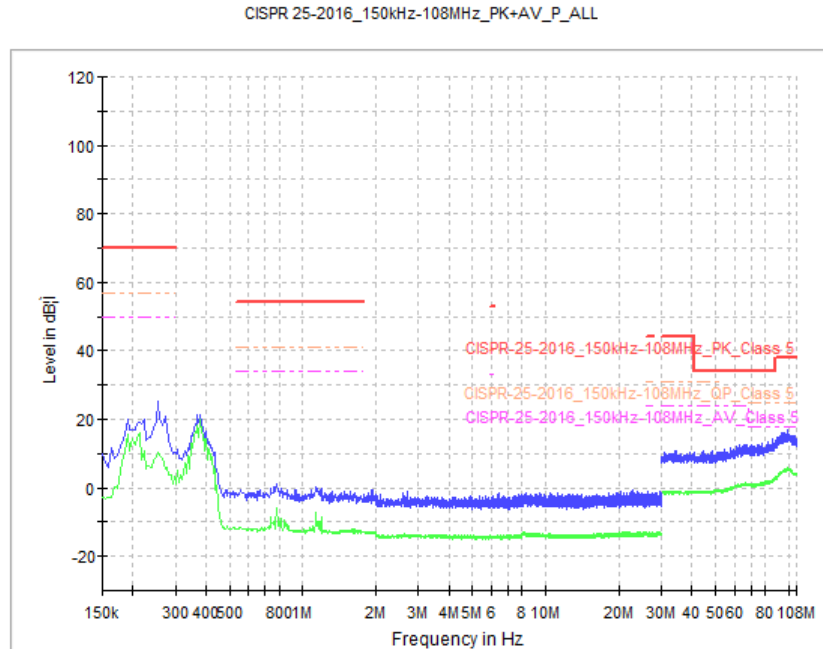
**Figure 2-9. Bode Plot, 13.5-V Input, 20-V, 3-A Load**



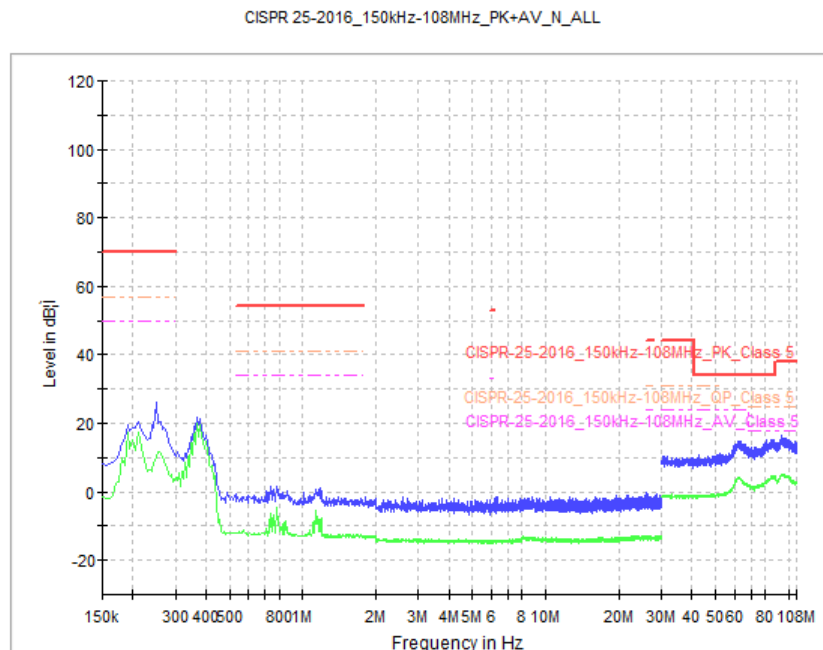
## 2.5 EMI

The conducted emissions are tested to the CISPR 25 class 5 standards. The CISPR 25 class-5 compliance was achieved without a common-mode choke. The waveforms of EMI test results are shown in following pictures.

The following images illustrate the EMI performance from 150 kHz to 108 MHz. Additionally, in every image:  
Line 1: CISPR 25 Class 5 peak limits;  
Line 2: CISPR 25 Class 5 average limits;  
Line 3: Peak detection result;  
Line 4: Average detection result.



**Figure 2-10. EMI Performance, 13.5-V Input, 5-V, 3-A Load, Positive Line**



**Figure 2-11. EMI Performance, 13.5-V Input, 5-V, 3-A Load, Negative Line**

CISPR 25-2016\_150kHz-108MHz\_PK+AV\_P\_ALL

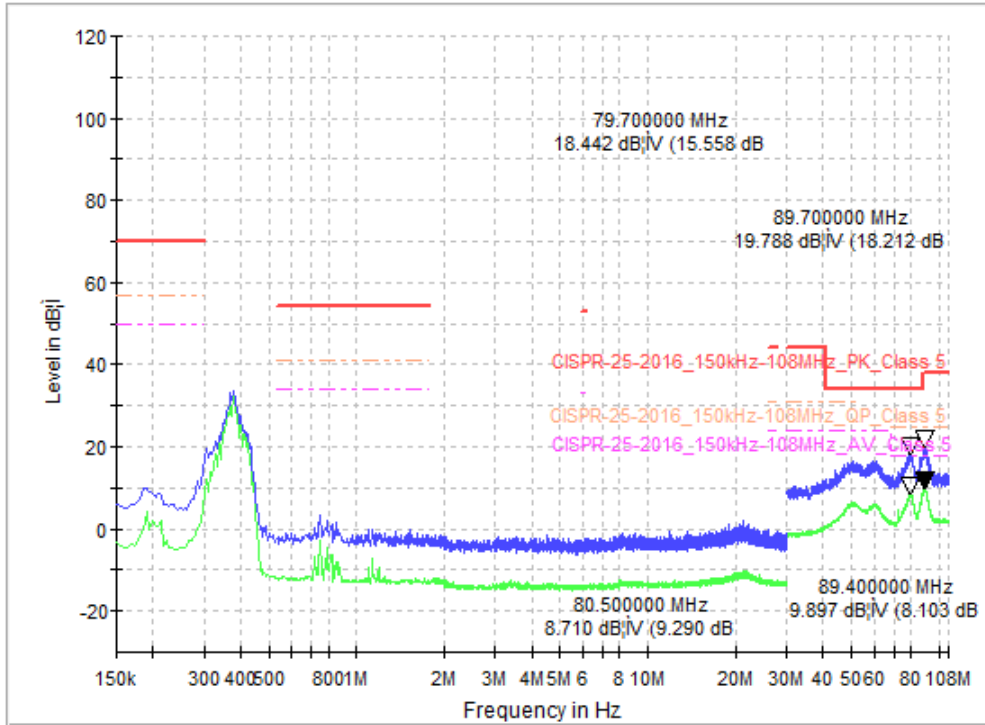


Figure 2-12. EMI Performance, 13.5-V Input, 9-V, 3-A Load, Positive Line

CISPR 25-2016\_150kHz-108MHz\_PK+AV\_N\_ALL

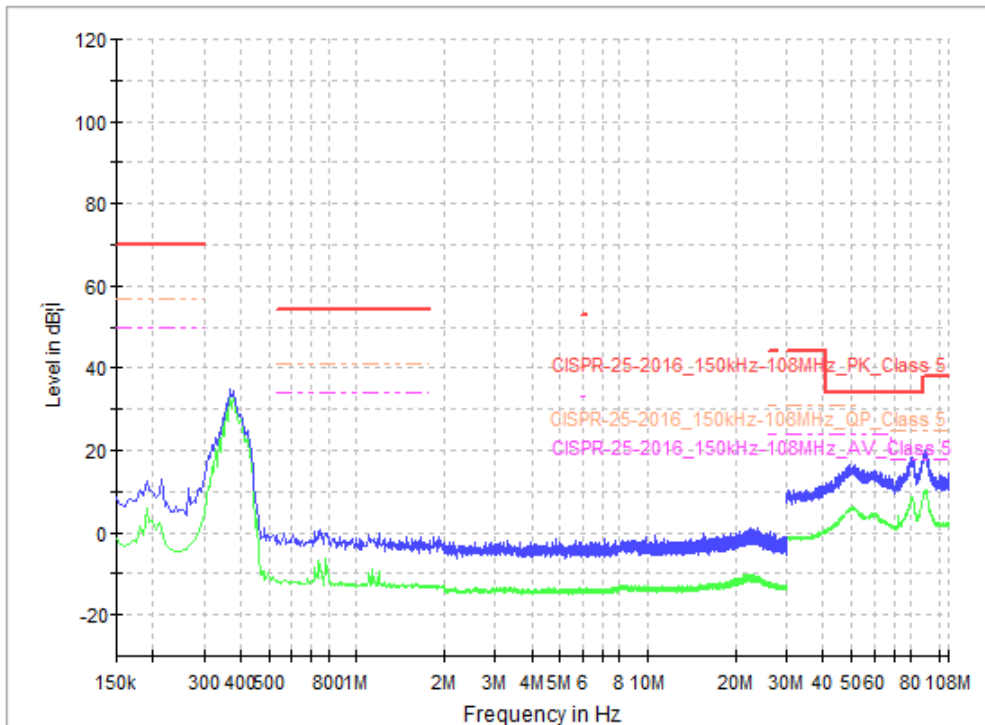


Figure 2-13. EMI Performance, 13.5-V Input, 9-V, 3-A Load, Negative Line

CISPR 25-2016\_150kHz-108MHz\_PK+AV\_P\_ALL

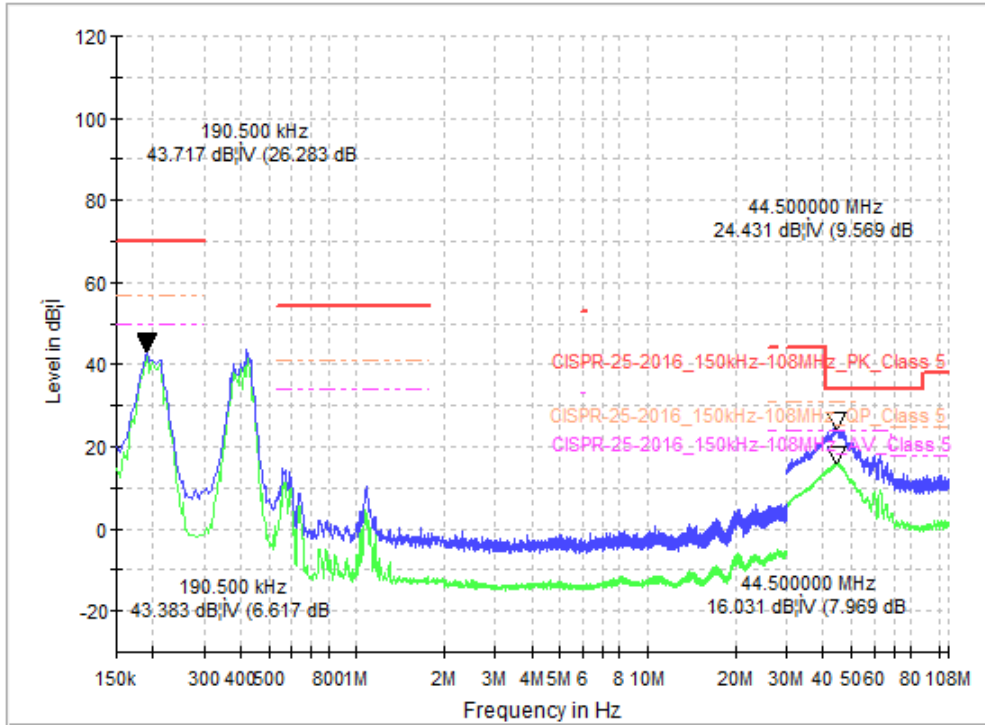


Figure 2-14. EMI Performance, 13.5-V Input, 15-V, 3-A Load, Positive Line

CISPR 25-2016\_150kHz-108MHz\_PK+AV\_N\_ALL

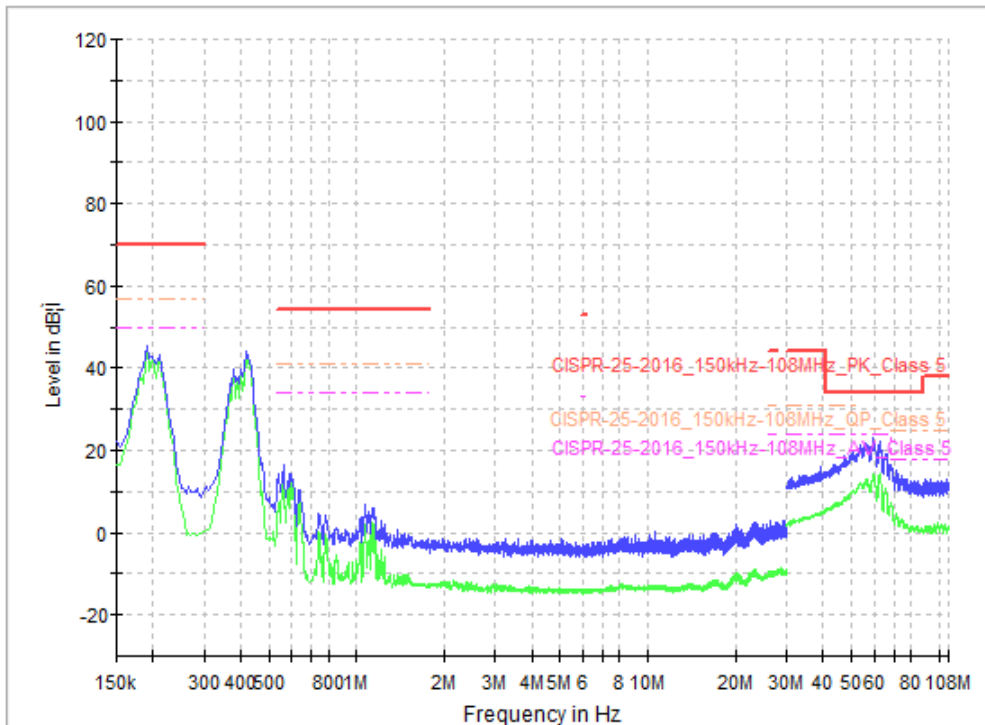


Figure 2-15. EMI Performance, 13.5-V Input, 15-V, 3-A Load, Negative Line

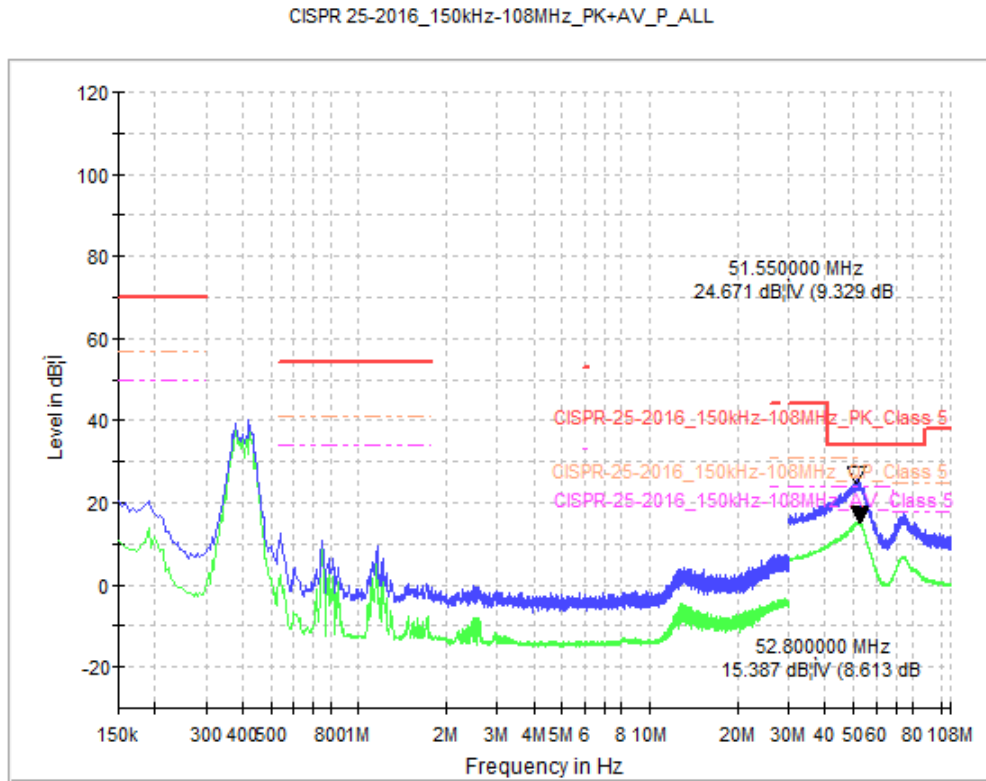


Figure 2-16. EMI Performance, 13.5-V Input, 20-V, 3-A Load, Positive Line

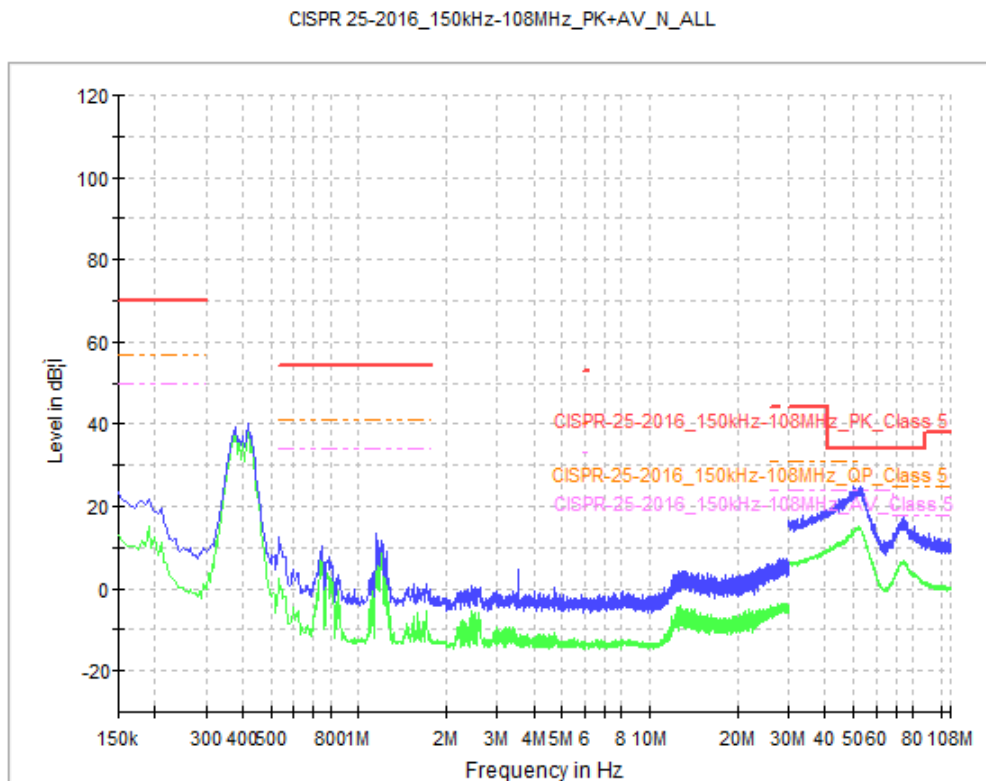


Figure 2-17. EMI Performance, 13.5-V Input, 20-V, 3-A Load, Negative Line

The margin of each EMI test result is shown in the following table.

**Table 2-2. EMI Test Results**

$V_{IN}$ (V)	$V_{OUT}$ (V)	Measurement Line	Margin (dB)
13.5	5	Positive line	13.1
13.5	5	Negative line	13.1
13.5	9	Positive line	8.7
13.5	9	Negative line	8.5
13.5	15	Positive line	6.6
13.5	15	Negative line	6.6
13.5	20	Positive line	8.6
13.5	20	Negative line	8.6

### 3 Waveforms

#### 3.1 Switching

The waveforms of switching nodes at full load condition are shown in following pictures.

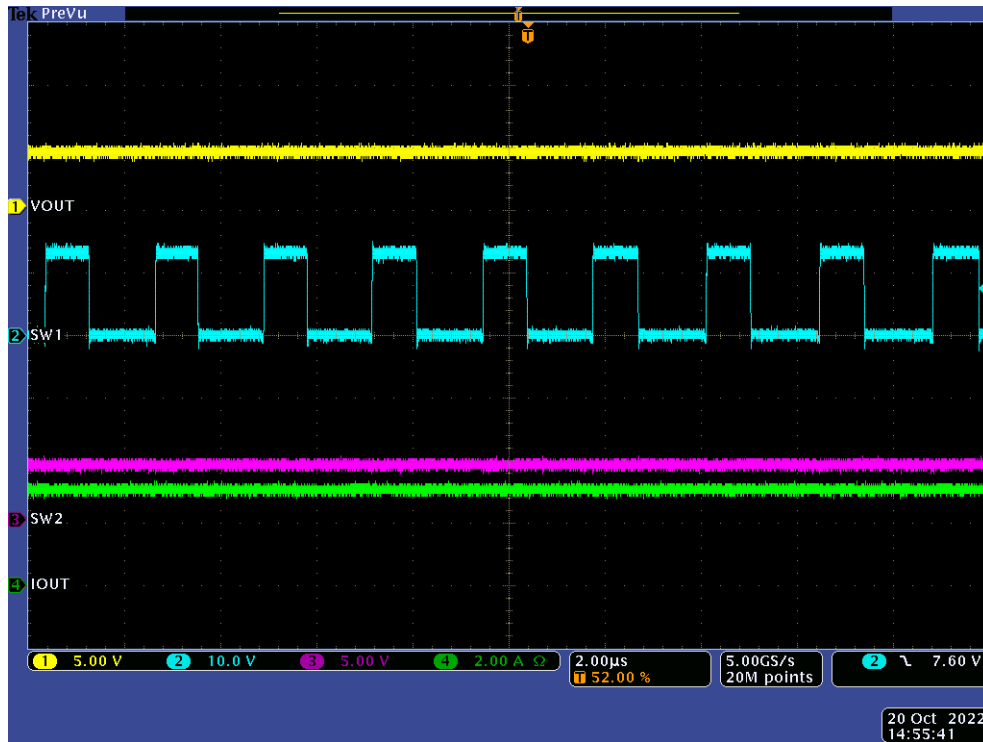


Figure 3-1. Switch-Node Voltage, 13.5-V Input, 5-V, 3-A Load

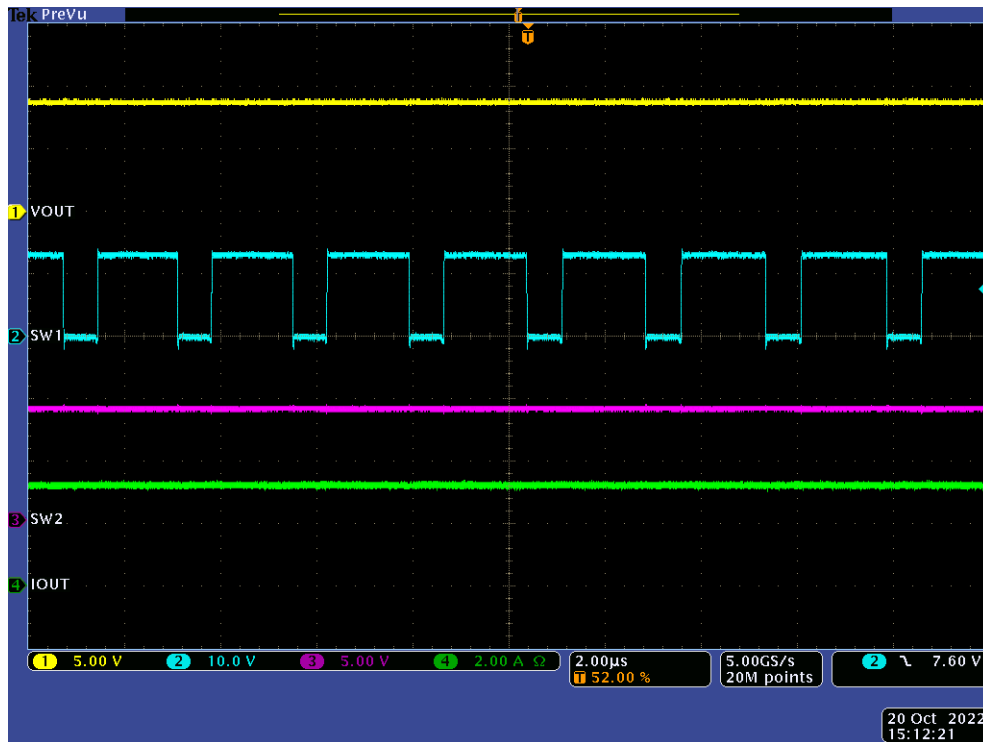


Figure 3-2. Switch-Node Voltage, 13.5-V Input, 9-V, 3-A Load

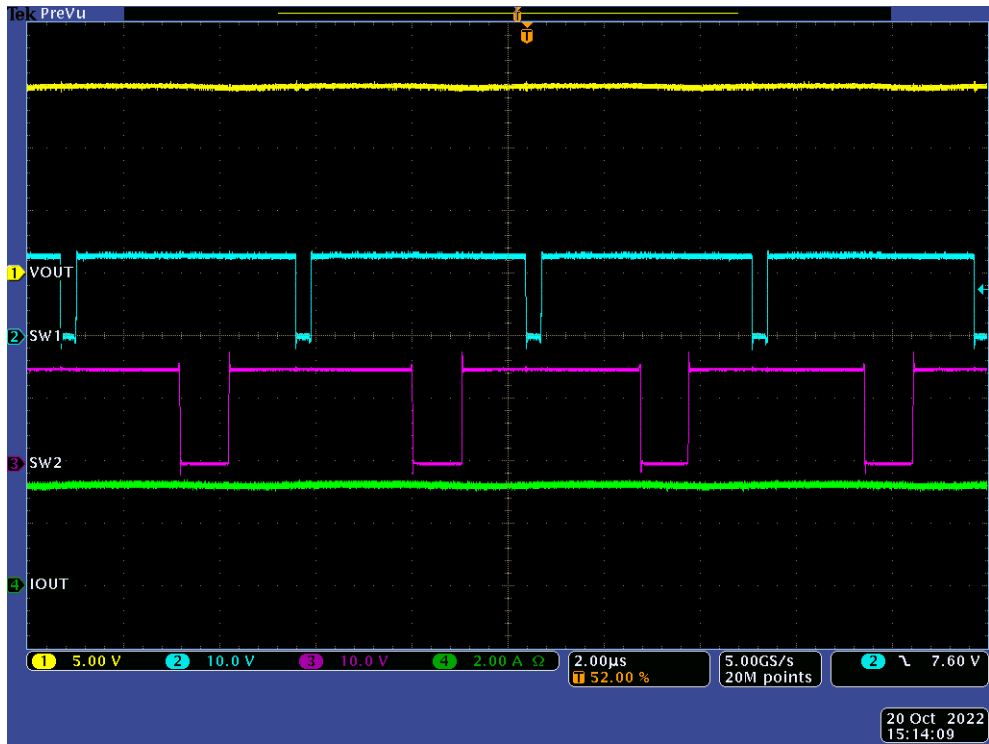


Figure 3-3. Switch-Node Voltage, 13.5-V Input, 15-V, 3-A Load

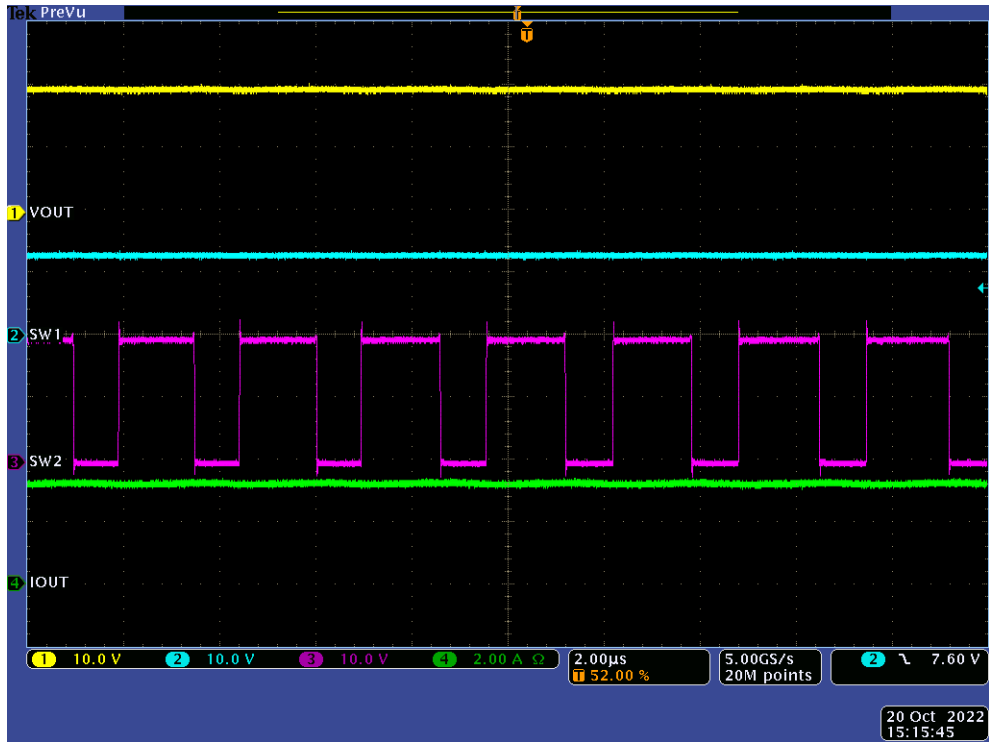


Figure 3-4. Switch-Node Voltage, 13.5-V Input, 20-V, 3-A Load

### 3.2 Output Voltage Ripple

The waveforms of output AC ripples at full load condition are shown in the images in this section. The following guidelines apply to each picture:

CH1:  $V_{OUT\_AC}$ , CH2:  $V_{OUT\_DC}$ , CH4:  $I_{OUT}$

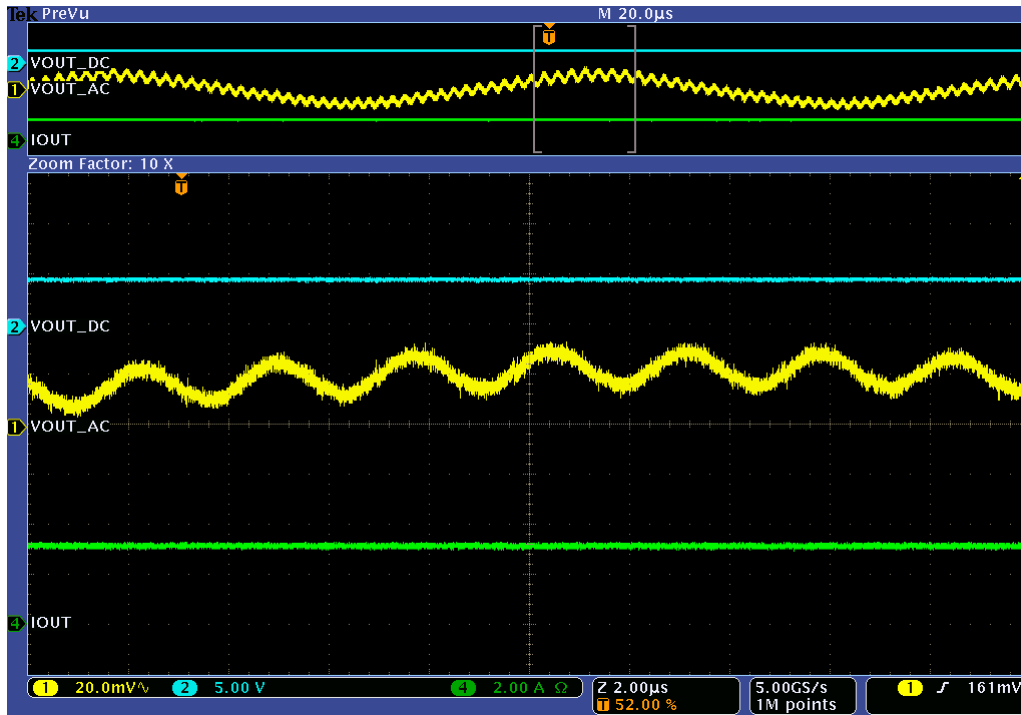


Figure 3-5. Output Voltage Ripple, 13.5-V Input, 5-V, 3-A Load

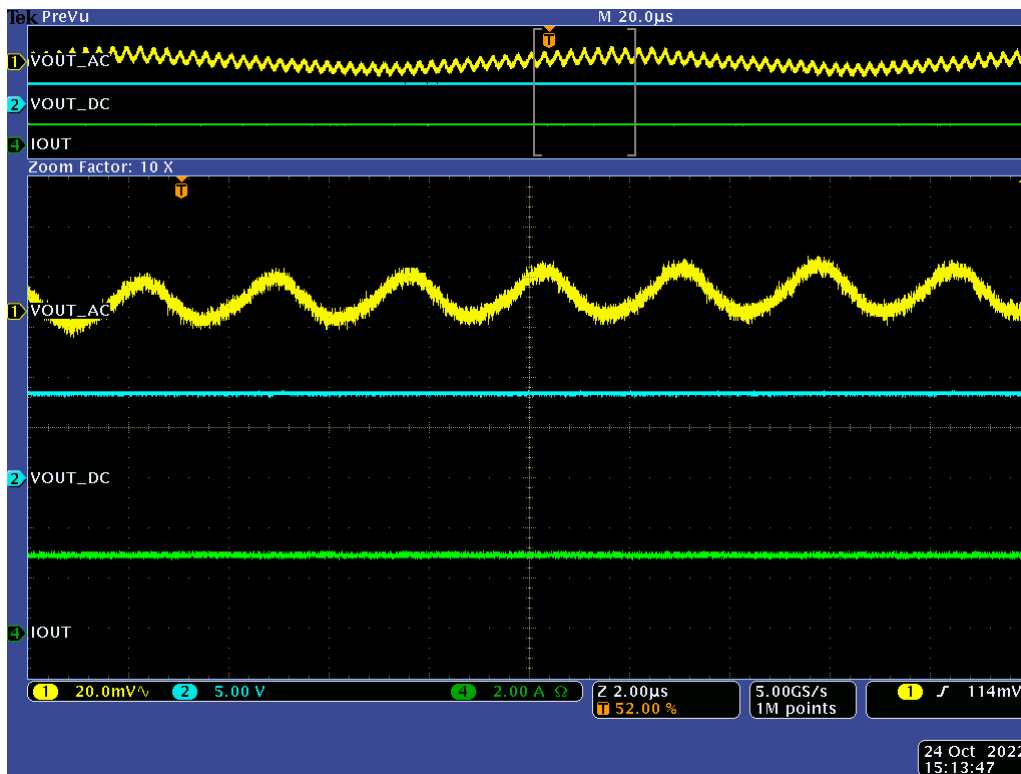


Figure 3-6. Output Voltage Ripple, 13.5-V Input, 9-V, 3-A Load



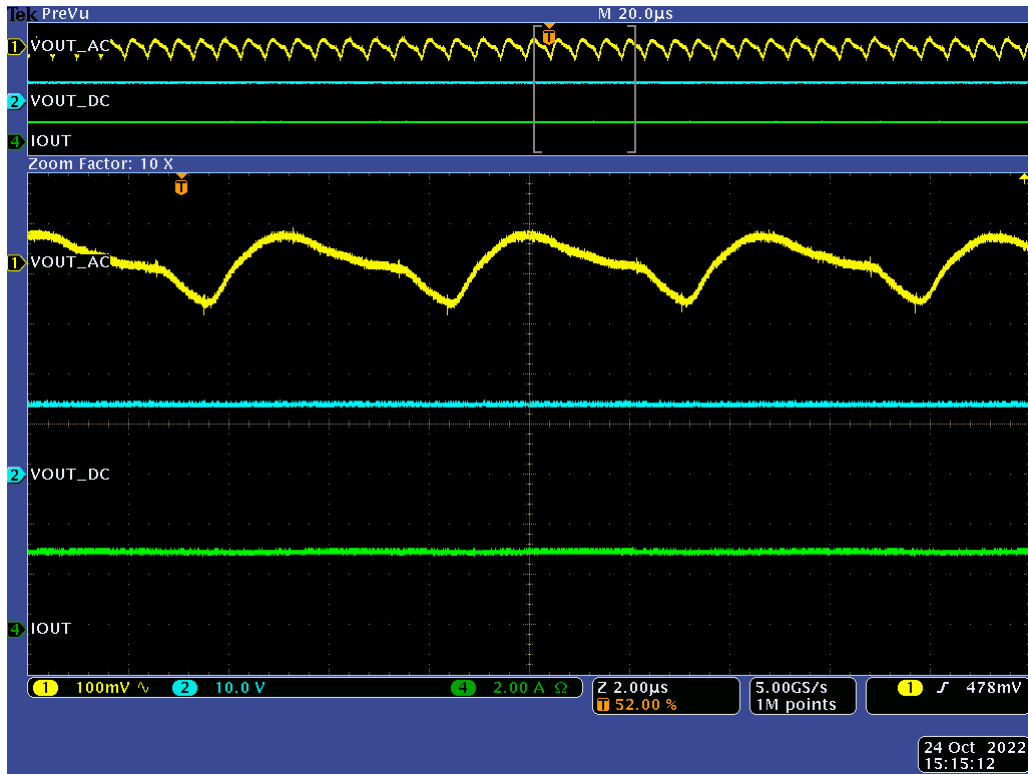


Figure 3-7. Output Voltage Ripple, 13.5-V Input, 15-V, 3-A Load

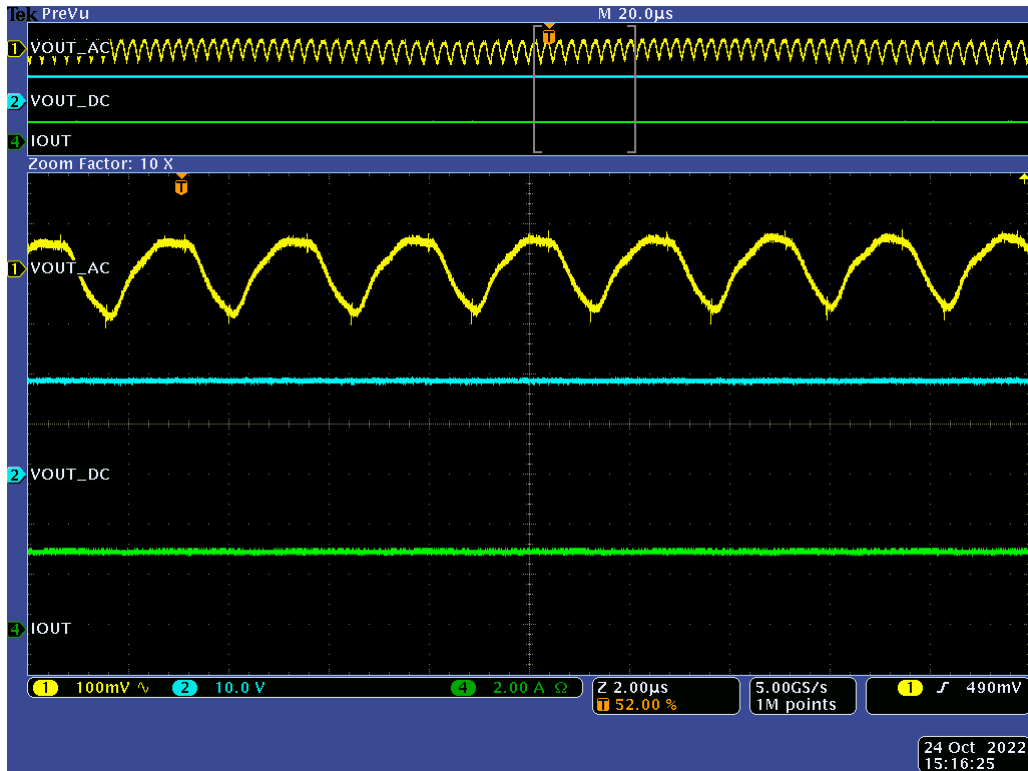


Figure 3-8. Output Voltage Ripple, 13.5-V Input, 20-V, 3-A Load

## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2023, Texas Instruments Incorporated